Product Description
DuPont LF152 is a filled, crystallizable screen-printed thick film dielectric composition and is an integral element of System LF. It is a lead free* dielectric intended for use in crossover applications.

Product Benefits
- Lead, Cadmium, Chromium and Nickel Free*
- Broad conductor compatibility (gold, silver and mixed metal)
- Compatible with cofirable conductors
- Highly resistant to EMF (electro-motive force) blistering and shorting
- Robust electrical and mechanical properties
- Thin, 2 print, hermetic dielectric film for protection against environmental conditions, and mechanical abrasion

*Cadmium and lead “free” as used herein means that these are not intentionally added to the referenced product. Trace amounts however may be present.

Design Note
The optimum yield in the most demanding applications, it is recommended that a fired thickness of 30 µm or greater is achieved between conductor layers.

Processing Conditions
Printing
230 to 280 stainless steel screen, at a print speed of 15cm/sec.

Drying
Allow prints to level for 10-15 minutes at room temperature, and then dry for 10-15 minutes at 150°C.

Typical Physical Properties

<table>
<thead>
<tr>
<th>Test</th>
<th>Properties</th>
</tr>
</thead>
<tbody>
<tr>
<td>Viscosity (Pa.s)</td>
<td>55-120</td>
</tr>
<tr>
<td>[Brookfield HBT, UC&amp;SP, 50 rpm, 25°C]</td>
<td></td>
</tr>
<tr>
<td>Coverage (cm²/g)</td>
<td>110-130</td>
</tr>
<tr>
<td>[Based on average fired thickness of 14mm]</td>
<td></td>
</tr>
<tr>
<td>Thinner</td>
<td>DuPont 4553</td>
</tr>
<tr>
<td>Total Fired Thickness (mm)</td>
<td>&gt; 30</td>
</tr>
<tr>
<td>Dielectric Constant (@1KHZ)</td>
<td>7-11</td>
</tr>
<tr>
<td>Dissipation Factor (@1KHZ)</td>
<td>&lt;0.5%</td>
</tr>
<tr>
<td>Leakage Current [µA/cm²]</td>
<td>&lt;1</td>
</tr>
<tr>
<td>Insulation Resistance [30µm]</td>
<td>&gt;10¹² @ 100VDC</td>
</tr>
<tr>
<td>Breakdown Voltage [30µm]</td>
<td>&gt;1000V/30mm</td>
</tr>
<tr>
<td>EMF Blister Resistance²</td>
<td>&gt;30 firing</td>
</tr>
</tbody>
</table>

1 Standard measurements made after 5 minutes at 10VDC
2 Measured deflection of 5 in by 1 in substrates with 5 circuit layers, single sided

This table shows anticipated typical physical properties for DuPont LF152 based on specific controlled experiments in our labs and are not intended to represent the product specifications, details of which are available upon request.

Firing
850°C peak held for 10 minutes on 30 minutes cycle in an air atmosphere.
**Recommended Processing Procedure**

**Substrates**
Substrates of different compositions and from various manufacturers may result in variation in performance properties.

**Thinner**
This composition is optimized for screen-printing, thinning is not normally required. Use the DuPont recommended thinner for slight adjustments to viscosity or to replace evaporation losses. The use of too much thinner or the use of a non-recommended thinner may affect the rheological behavior of the material and its printing characteristics. Refer to table 1.

**Printing**
The composition should be thoroughly mixed before use. This is best achieved by slow, gently, hand stirring with a clean burr-free spatula (flexible plastic) for 1-2 minutes. Care must be taken to avoid air entrapment. Printing should be performed in a clean and well-ventilated area. Note: optimum printing characteristics are generally achieved in the room temperature range of 20°C – 23°C. It is therefore important that the material, in its container, is at this temperature prior to commencement of printing.

**Drying**
Allow prints to level at room temperature, and then dry in a well-ventilated oven or conveyor dryer.

**Firing**
Fire in a well ventilated belt, conveyor furnace, or static furnace. Airflows and extraction rates should be optimized to ensure that oxidizing conditions exist within the muffle.

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Storage and Shelf Life
Containers should be stored, tightly sealed, in a clean, stable environment at room temperature (<25°C). Shelf life of material in unopened containers is six months from date of shipment. Some settling of solids may occur and compositions should be thoroughly mixed prior to use.

Safety and Handling
For Safety and Handling information pertaining to this product, read the Material Safety Data Sheet (MSDS).

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